

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

FFIQE Response

In re the Application of: Chakravarthi et al.

Docket No. TI-33161

Serial No. 10/020,813

Art Unit: 2813

Filed: 12/12/01

Examiner:Yennhu B. Huyh

Title:

Fabrication of Ultra Shallow Junctions From a Solid Source With Fluorine

Implantation

## REPLY UNDER 37 CFR 1.116 – EXPEDITED PROCEDURE TECHNOLOGY CENTER 2800

Burney Bright

March 5, 2003

Assistant Commissioner for Patents Washington, D. C. 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C.

3-5-03

Karen Vertz

Date

Dear Sir:

In response to the Office Action, dated 1/14/03, in the above-identified patent application, please make the following amendments. They are respectfully submitted as a full and complete response to that Action. Charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.

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